

## **Internship at Intel/Chandler, AZ**

Our team works on new/novel semiconductor packaging technologies for high speed signaling applications and associated modeling & measurement methods. The internship would involve some work most likely on the modeling side and potentially on some optimization topic. The required skill is basically a good fundamental education on electromagnetics. Any experience on any commercial tools such as HFSS would also help but I understand not all students get exposed to that.